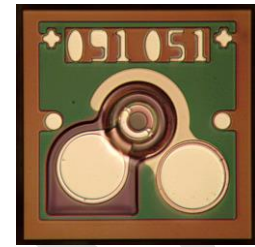


## DESCRIPTION

Inneos' 1000nm 12 Gbps VCSEL was designed for commercial operation from 0°C to 85°C to meet the needs of commercial, medical, and industrial applications. The device allows for wirebond assemblies to support a variety of packaging options.



## FEATURES


- Operating temperature from 0°C to 85°
- Operation up to 12 Gbps
- Top-emitting
- Single channel

## APPLICATIONS

- Transmitter Optical Sub-Assemblies
- Transceivers


## ORDERING INFORMATION

PART NUMBER	DESCRIPTION
V1000-12GSA-1THA	12 Gbps 1000 nm VCSEL, Bare Die, 0°C to 85°C



**ATTENTION: OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DEVICES**

Stress conditions greater than those listed under "Absolute Maximum Ratings" may permanently damage the device. Operation of devices beyond these stress conditions for extended periods may effect device reliability.



**CAUTION**

INVISIBLE LASER RADIATION  
AVOID BEAM EXPOSURE  
CLASS 3B LASER

## ABSOLUTE MAXIMUM RATINGS

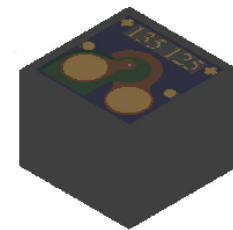
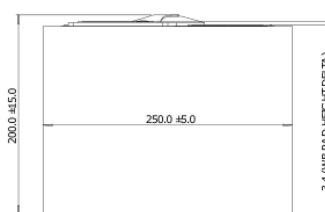
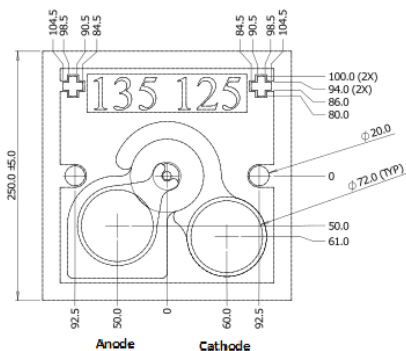
PARAMETER	SYMBOL	MIN	MAX	UNITS
Storage Temperature Range	T <sub>S</sub>	-40	100	°C
Operating Temperature Range	T <sub>O</sub>	0	85	°C
Reverse Voltage	V <sub>R</sub>		8	V
Continuous Forward Current	I <sub>F</sub>		10	mA
ESD Protection (HBM)			200	V

## OPTICAL/ELECTRICAL SPECIFICATIONS

PARAMETER	CONDITIONS	SYMBOL	UNITS	MIN	TYPICAL	MAX
Emission Wavelength	T <sub>o</sub> =0 to 85°C @ 5 to 8mA	$\lambda_c$	nm	994.0	1000	1008.0
Variation of Wavelength with Temperature	-	$\frac{\Delta\lambda}{\Delta T}$	nm/°C	-	0.07	-
Spectral Width <sup>a</sup>	T <sub>o</sub> =0°C @ 6mA	$\sigma_\lambda$	nm	-	0.25	0.85
	T <sub>o</sub> =85°C @ 6mA					
Threshold Current <sup>b</sup>	T <sub>o</sub> =0°C, 85°C	I <sub>th</sub>	mA	-	-	1.2
	T <sub>o</sub> =30°C			-	0.8	-
Average Operating Current		I <sub>avg</sub>	mA	-	5	-
Operating Voltage	T <sub>o</sub> =0°C @ 5mA	V <sub>o</sub>	V	-	-	2.5
	T <sub>o</sub> =85°C @ 5mA			-	2.0	-
Optical Output Power	T <sub>o</sub> =0°C, 85°C @ 5mA	P <sub>o</sub>	mW	1.0	1.9	-
	T <sub>o</sub> =30°C @ 5mA			-	2.0	-
Small Signal Bandwidth <sup>c</sup>	T <sub>o</sub> =85°C @ 6mA	f <sub>3dB</sub>	GHz	-	9	-
Relative Intensity Noise <sup>d</sup>	T <sub>o</sub> =85°C @ 7mA	RIN <sub>12</sub>	dB/Hz	-	-128	-
Beam Divergence Half Angle (1/e <sup>2</sup> ) <sup>e</sup>	T <sub>o</sub> =30°C @ 5mA	$\theta_{1/2}$	deg	-	15	-
Slope Efficiency <sup>f</sup>	T <sub>o</sub> =0°C	SE	mW/mA	-	0.53	-
	T <sub>o</sub> =85°C			-	0.47	-
Differential Resistance <sup>g</sup>	T <sub>o</sub> =0°C @ 8mA	R <sub>diff</sub>	$\Omega$	-	120	-
	T <sub>o</sub> =85°C @ 8mA			-	70	-

## MECHANICAL OUTLINE

Dimensions are in microns.



- NOTES UNLESS OTHERWISE SPECIFIED:  
 1. INTERPRET DRAWING IN ACCORDANCE WITH ASME Y14.5-2009.  
 2. SUBSTRATE MATERIAL: GaAs.  
 3. WIREBOND PAD MATERIAL: 1 μm GOLD.  
 4. WIREBOND SHALL BE FULLY CONTAINED WITHIN BOND PAD OPENINGS.

ELECTROSTATIC-DISCHARGE SENSITIVE DEVICE:  
 FOLLOW ESD PROTECTIVE HANDLING PROCEDURES  
 IN ACCORDANCE WITH ANSI/ESD S20.20-2014.

**PARAMETER CALCULATION METHODS USED**

a. Spectral width is calculated based on FOTP-127 where the spectral level of the measured spectra below 20dB from maximum value are made zero and RMS spectral width is calculated based on formula

$$\Delta\lambda_{RMS} = \sqrt{\frac{\sum_{i=1}^N P_i \lambda_i^2}{\sum_{i=1}^N P_i} - \left(\frac{\sum_{i=1}^N P_i \lambda_i}{\sum_{i=1}^N P_i}\right)^2}$$

where 'λ<sub>i</sub>' is the wavelength and 'P<sub>i</sub>' is the optical power level of the i<sup>th</sup> point in the spectra.

b. The threshold current is derived by a linear fit method using 10% and 20% of peak optical power points. Threshold current is the point at which the optical power is zero using the linear fit.

c. The small signal bandwidth is obtained from optical response measurements at set current and reading the cut off frequency at which the power level is 3dB down from the power level at DC.

d. Relative intensity noise: RIN<sub>12</sub> is the DC-RIN measured with -12dB return. The DC-RIN is measured using an electrical spectrum analyzer with resolution bandwidth set to 1MHz, calibrated photodetector and broad-band amplifiers. The RIN per unit bandwidth is calculated using the formula,

$$RIN \left(\frac{dB}{Hz}\right) = RIN [dBm] - 10\log_{10}(I_p^2 R_m) [dBm] - A [dB] - 10\log_{10}(\Delta f [GHz])$$

where 'RIN' is the peak RIN on electrical spectrum analyzer with resolution bandwidth 'Δf', 'I<sub>p</sub>' is the measured photocurrent, 'R<sub>m</sub>' is the input resistance of measurement system, and 'A' is the amplification.

e. Beam divergence half-angle is derived from measurement of optical power in far-field at various angles. The half-angle is the angular deviation from center where the power reduces by '1/e'.

f. The slope efficiency is derived by linear fit method using 10% and 20% of peak optical power points. Slope efficiency is the slope of the lineal fit of optical power and drive current.

g. Differential resistance at point 'i' of the measured LIV is calculated based on formula,

$$R_{diff} = \frac{V_i - V_{i-1}}{I_i - I_{i-1}}$$

where 'V<sub>i</sub>', 'V<sub>i-1</sub>' are the measured voltages at set currents 'I<sub>i</sub>' and 'I<sub>i-1</sub>' respectively.